

Sheet 1 of 1

Form PTO-1449 (REV. 8-83)		US Dept. of Commerce PATENT & TRADEMARK OFFICE		ATTY DOCKET NO. 115556		APPLICATION NO. 10/766,806	
INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)				APPLICANT(S) Takao SAITO et al.			
				FILING DATE January 30, 2004		GROUP 1762	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	
	1.	JP A 62-136569	6/19/1987	JAPAN			
	2.	JP A 2002-339072 w/abstract & transl.	11/27/2002	JAPAN			
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)							
EXAMINER				DATE CONSIDERED			
				9/14/05			
Examiner: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

Date: February 27, 2004

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EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	
	1.	US 2002/0170495 A1	11/21/2002	NAKAMURA et al.			
	2.	US 2002/0182319 A1	12/5/2002	BEN-MALEK et al.			
	3.	5,236,511	8/17/1993	ETZKORN et al.			
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)							
	4.	Frank Jansen et al.; "Thin film deposition on inside surfaces by plasma enhanced chemical vapor deposition"; XP000474735; Thin Solid Films, Elsevier, Vol. 252, No. 1; November 15, 1994; pp 32-37					
EXAMINER				DATE CONSIDERED <u>9/14/05</u>			
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Date: November 19, 2004